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FDMS86350ET80 N-Channel PowerTrench[®] MOSFET 80 V, 198 A, 2.4 mΩ

Features

- Extended T_J rating to 175°C
- Max $r_{DS(on)}$ = 2.4 m Ω at V_{GS} = 10 V, I_D = 25 A
- Max $r_{DS(on)}$ = 3.2 m Ω at V_{GS} = 8 V, I_D = 22 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

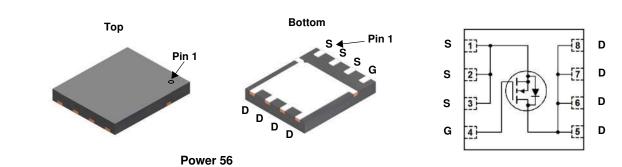


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench® process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Applications

- Primary MOSFET
- Synchronous Rectifier
- Load Switch
- Motor Control Switch



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			80	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	198		
	-Continuous	T _C = 100 °C	(Note 5)	140	A	
D	-Continuous	T _A = 25 °C	(Note 1a)	25	A	
	-Pulsed		(Note 4)	693		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	864	mJ	
Р	Power Dissipation	T _C = 25 °C		187	w	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	3.3	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 45	C/ W

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86350ET	FDMS86350ET80	Power 56	13 "	12 mm	3000 units

January 2015

Units	FDMS86350ET80 N-Channel PowerTrench
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·D22	Loro dato Voltago Brain Garroni	·DS - • · · , •GS - • •				pur
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Char	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250 \ \mu A$	2.5	3.8	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-12		mV/°C
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 25 \text{ A}$		2.0	2.4	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 8 V, I _D = 22 A		2.5	3.2	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 25 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		3.1	3.8	
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 25 A		70		S
-	Characteristics			8030		۶E
C _{iss}	Input Capacitance	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ = 1 MHz		8030		pF
C _{oss}	Output Capacitance			1370		pF
C _{rss}	Reverse Transfer Capacitance			31		pF
Rg	Gate Resistance		0.1	1.1	3	Ω
Switchin	g Characteristics					
t _{d(on)}	Turn-On Delay Time			50	80	ns
t _r	Rise Time	V _{DD} = 40 V, I _D = 25 A,		34	55	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		40	65	ns
t _f	Fall Time			11	20	ns
Qg	Total Gate Charge	V _{GS} = 0 V to 10 V		110	155	nC
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 8 V V_{DD} = 40 V,$		90	127	nC
Q _{qs}	Gate to Source Charge	I _D = 25 A		46		nC

Test Conditions

 $I_D = 250 \ \mu$ A, referenced to 25 °C

 $I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$

 $V_{DS} = 64 \text{ V}, V_{GS} = 0 \text{ V}$

Min

80

Тур

45

Мах

1

Drain-Source Diode Characteristics

Gate to Drain "Miller" Charge

Electrical Characteristics T_J = 25 °C unless otherwise noted

Parameter

Drain to Source Breakdown Voltage

Breakdown Voltage Temperature

Zero Gate Voltage Drain Current

V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)	0.71	1.2	V	
		V _{GS} = 0 V, I _S = 25 A (Note 2)	0.79	1.3	v	
t _{rr}	Reverse Recovery Time	I _E = 25 A, di/dt = 100 A/μs	63	101	ns	
Q _{rr}	Reverse Recovery Charge	$F = 25 \text{ A}, \text{ di/dt} = 100 \text{ A/} \mu \text{s}$	62	100	nC	

Notes:

Q_{gd}

Symbol

BV_{DSS}

 ΔBV_{DSS}

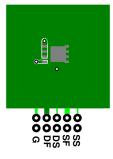
 ΔT_J

IDSS

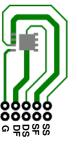
Off Characteristics

Coefficient

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0CA} is determined by the user's board design.



a. 45 °C/W when mounted on a 1 in² pad of 2 oz copper.



b. 115 °C/W when mounted on a minimum pad of 2 oz copper.

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2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

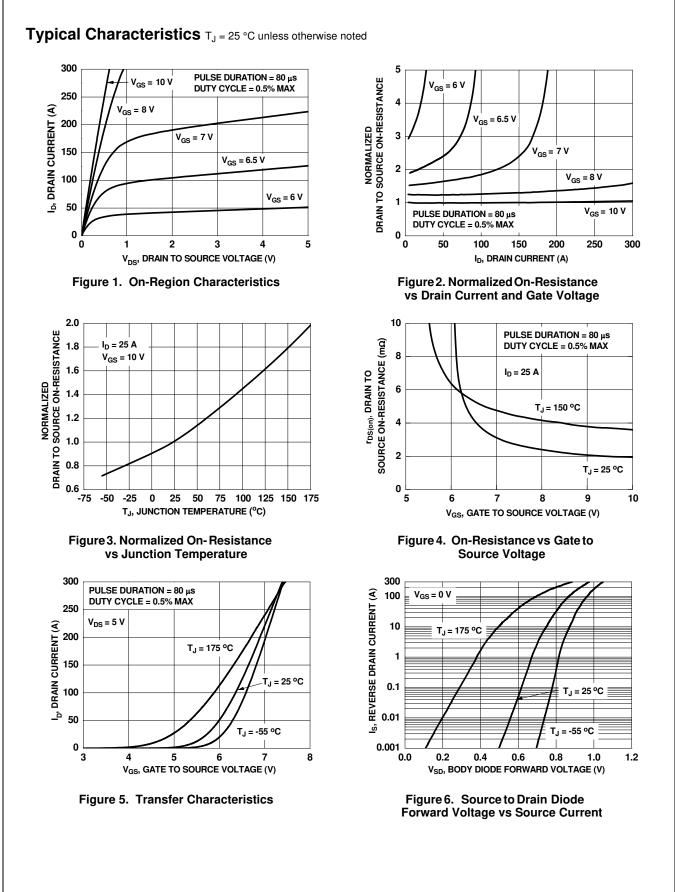
3. E_{AS} of 864 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 24 A, V_{DD} = 80 V, V_{GS} = 10 V, 100% test at L = 0.1 mH, I_{AS} = 74 A.

4. Pulse Id please refer to Fig.11 SOA curve for more details.

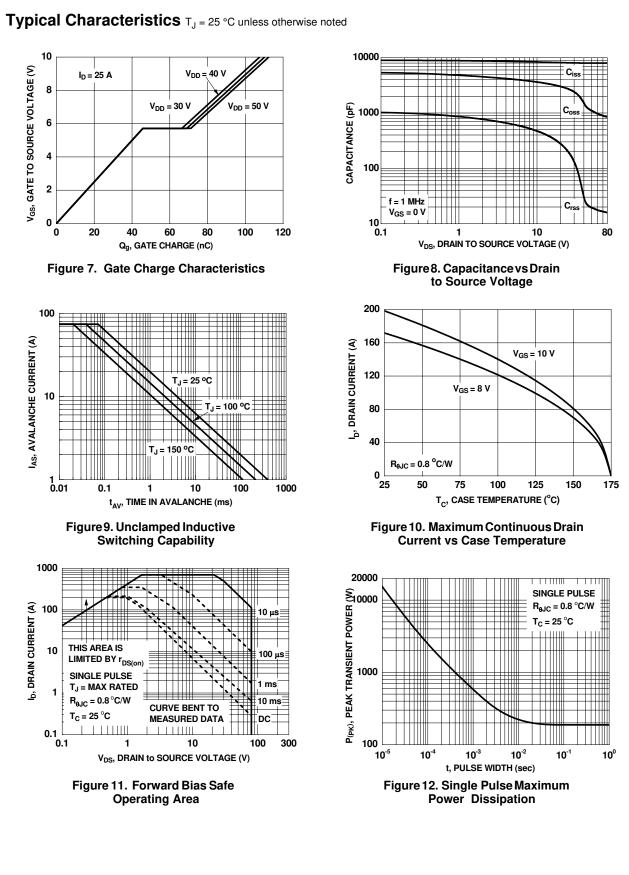
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

nC

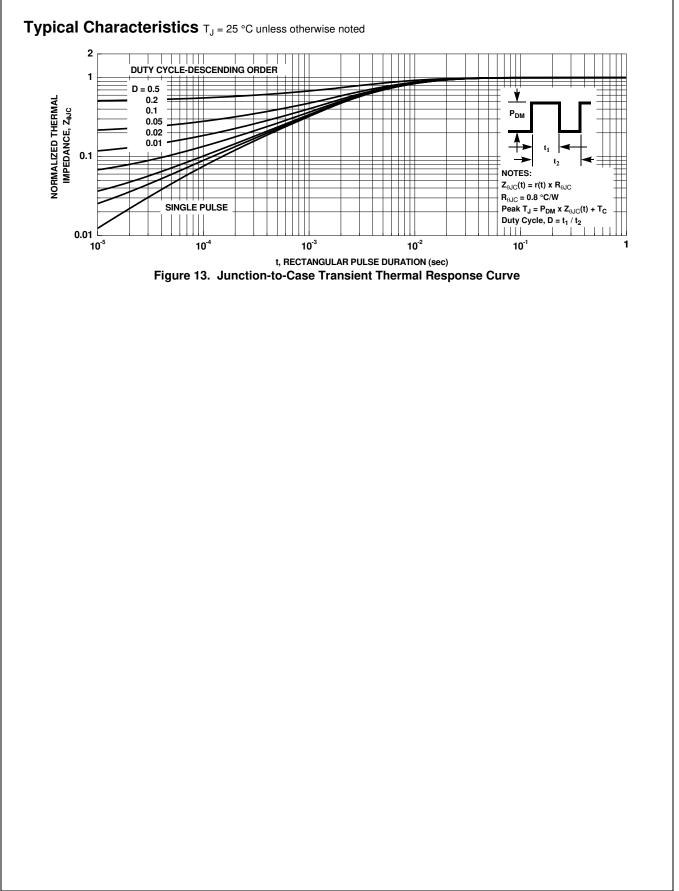
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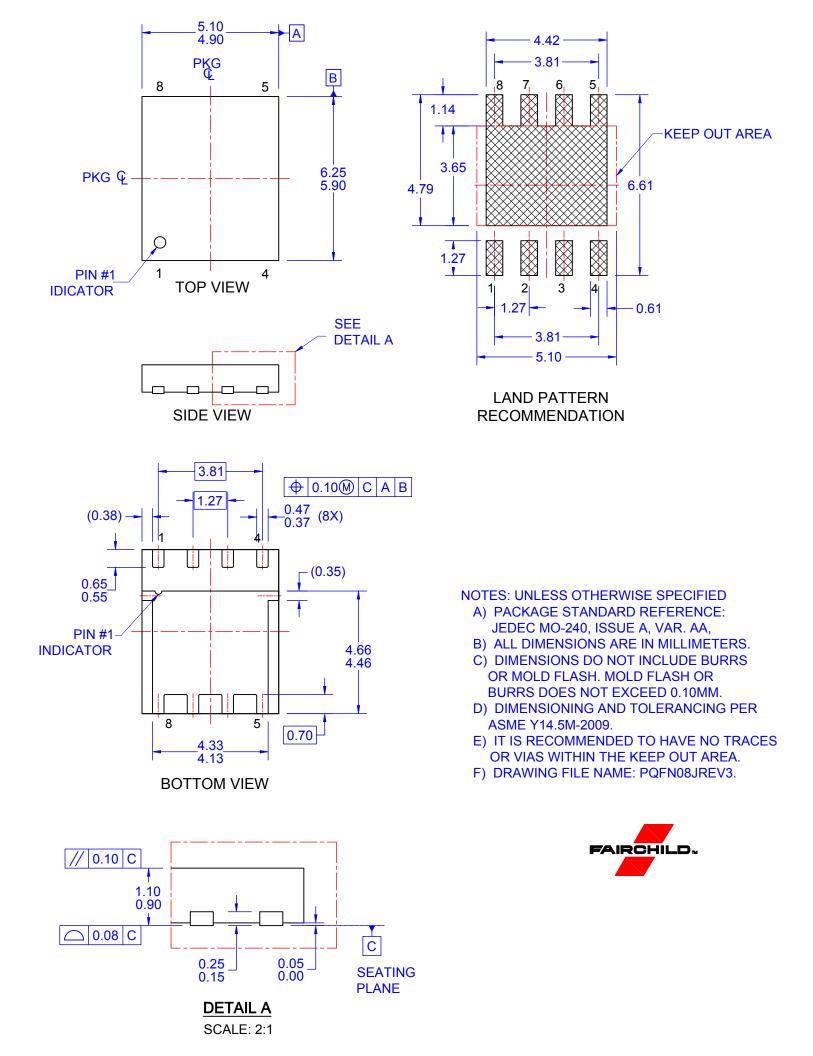
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